# Integrated Dual Channel Switch and LNA Module 2-6 GHz 

## Features

- Dual Channel Architecture
- Broadband: 2-6 GHz
- High Power Switch Handling ( $\mathrm{T}_{\mathrm{C}}=105^{\circ} \mathrm{C}$ ):

43 dBm LTE 8 dB PAR (<10 s, single event)
40 dBm LTE 8 dB PAR (Lifetime)

- Second LNA has Bypass Mode
- Rx High Gain Mode:

Gain: 35 dB at $2.6 \mathrm{GHz}, 34 \mathrm{~dB} @ 3.5 \mathrm{GHz}$
NF: 1.3 dB at $2.6 \mathrm{GHz}, 1.5 \mathrm{~dB} @ 3.5 \mathrm{GHz}$ OIP3: 35.5 dBm

- Rx Low Gain Mode:

Gain: 19.3 dB at $2.6 \mathrm{GHz}, 19.5 \mathrm{~dB} @ 3.5 \mathrm{GHz}$
NF: 1.2 dB at $2.6 \mathrm{GHz}, 1.5 \mathrm{~dB} @ 3.5 \mathrm{GHz}$ OIP3: 30.5 dBm

- Single 5 V Supply, 115 mA per channel
- Compatible with 1.8 V and 3.3 V logic
- Lead-Free 6 mm 40-Lead QFN Package
- RoHS* Compliant


## Applications

- 5G Massive MIMO
- Wireless Infrastructure
- TDD-based communication systems


## Description

The highly integrated Dual Channel Switch and LNA Module includes two Antenna Switches and two 2-stage low noise amplifiers in a compact low cost 6 mm QFN package. The second stage LNAs can be bypassed. Mixed technologies are used to achieve high power handling, low noise figure, and low power consumption. The module only needs a single +5 V supply. T/R switch, LNA enable, and bypass function can be controlled with 1.8 V or 3.3 V logic.

Ordering Information ${ }^{1}$

| Part Number | Package |
| :---: | :---: |
| MAMF-011133-TR1000 | 1000 part reel |
| MAMF-011133-001SMB | Sample Board |

1. Reference Application Note M513 for reel size information.

## Functional Schematic



Pin Configuration ${ }^{2,3,4}$

| Pin \# | Function |
| :---: | :---: |
| $1,2,4,7,9-11,13,14,21$, <br> $23,28,30,37,38,40$ | Ground |
| 3 | Antenna Input ChA |
| 5 | Switch Control ChA\&B |
| $6,15,16,18-20,25,31-33$, <br> 35,36 | No Connect |
| 8 | Antenna Input ChB |
| 12 | Load ChB |
| 17 | Switch/LNA VDD ChB |
| 22 | LNA Bypass ChB |
| 24 | LNA Enable ChA\&B |
| 26 | LNA Bypass ChA |
| 27 | Rx Output ChA |
| 29 | Switch/LNA VDD ChA |
| 34 | Load ChA |
| 39 |  |

2. Blocking Capacitors are required on all RF Ports.
3. MACOM recommends connecting unused package pins to ground.
4. The exposed pad centered on the package bottom must be connected to RF, DC and thermal ground.
[^0]Electrical Specifications: Freq. $=2.6 \mathrm{GHz}, \mathrm{P}_{\mathrm{IN}}=-35 \mathrm{dBm}, \mathrm{T}_{\mathrm{C}}=+25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V}, \mathrm{Z}_{0}=50 \Omega$

| Parameter | Conditions | Units | Min. | Typ. | Max. |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Gain at Rx High Gain Mode | 2.6 GHz 5.0 GHz | dB | $\begin{aligned} & 31 \\ & 30 \\ & 29 \end{aligned}$ | $\begin{aligned} & 35 \\ & 34 \\ & 32 \end{aligned}$ | - |
| NF at Rx High Gain Mode | 2.6 GHz 3.5 GHz 5.0 GHz | dB | - | 1.3 1.5 1.7 | - |
| Input RL at Rx High Gain Mode | - | dB | - | 18 | - |
| Output RL at Rx High Gain Mode | - | dB | - | 15 | - |
| Output IP3 at Rx High Gain Mode | $\begin{aligned} & \text { Tone Spacing }=10 \mathrm{MHz} \\ & \text { Pout } / \text { Tone }=+3 \mathrm{dBm} \\ & \text { Pout } / \text { Tone }=+10 \mathrm{dBm} \end{aligned}$ | dBm | - | $\begin{gathered} 33 \\ 35.5 \end{gathered}$ | - |
| Output P1dB at Rx High Gain Mode | - | dBm | - | 19.5 | - |
| Gain at Rx Low Gain Mode | $\begin{aligned} & 2.6 \mathrm{GHz} \\ & 3.5 \mathrm{GHz} \\ & 5.0 \mathrm{GHz} \end{aligned}$ | dB | $\begin{aligned} & 17 \\ & 17 \\ & 16 \end{aligned}$ | $\begin{aligned} & 19.3 \\ & 19.5 \\ & 19.0 \end{aligned}$ | - |
| NF at Rx Low Gain Mode | $\begin{aligned} & 2.6 \mathrm{GHz} \\ & 3.5 \mathrm{GHz} \\ & 5.0 \mathrm{GHz} \end{aligned}$ | dB | - | 1.2 1.5 1.7 | - |
| Input RL at Rx Low Gain Mode | - | dB | - | 15 | - |
| Output RL at Rx Low Gain Mode | - | dB | - | 11.5 | - |
| Output IP3 at Rx Low Gain Mode | $\begin{aligned} & \text { Tone Spacing }=10 \mathrm{MHz} \\ & \text { Pout } / \text { Tone }=+3 \mathrm{dBm} \end{aligned}$ | dBm | - | 30.5 | - |
| Output P1dB at Rx Low Gain Mode | - | dBm | - | 15.5 | - |
| Insertion Loss at Tx Mode | - | dB | - | 0.35 | - |
| Return Loss at Tx Mode | - | dB | - | 25 | - |
| Power Handling at Tx Mode | Average Power (8 dB PAR) | W | - | 10 | - |
| Supply Voltage | - | V | 4.75 | 5.0 | 5.25 |
| Control Voltage | Logic High Logic Low | V | $\begin{gathered} 1.2 \\ 0 \end{gathered}$ | - | $\begin{gathered} 3.45 \\ 0.6 \end{gathered}$ |
| Logic Input Current | Logic High Logic Low | $\mu \mathrm{A}$ | - | $\begin{gathered} +80 \\ -2 \end{gathered}$ | - |
| Supply Current ( $\mathrm{V}_{\mathrm{DD}}$ ) per Channel | Rx High Gain Rx Low Gain Tx mode | mA | - | $\begin{gathered} 115 \\ 50 \\ 2 \end{gathered}$ | - |

Electrical Specifications: Freq. $=2.6 \mathrm{GHz}, \mathrm{P}_{\mathrm{IN}}=-35 \mathrm{dBm}, \mathrm{T}_{\mathrm{C}}=+25^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V}, \mathrm{Z}_{\mathbf{0}}=50 \Omega$

| Parameter | Conditions | Units | Min. | Typ. | Max. |
| :---: | :---: | :---: | :---: | :---: | :---: |
| RF Switching Time | 50\% CTL to 10/90\% RF | ns | - | 500 | - |
| High/Low Gain Mode Switching Time | 50\% CTL to 10/90\% RF | ns | - | 150 | - |
| Isolation Between Rx Channels ${ }^{5}$ | $\begin{aligned} & \text { 2.6 GHz } \\ & 3.5 \mathrm{GHz} \\ & 5.0 \mathrm{GHz} \end{aligned}$ | dB | - | $\begin{aligned} & 47.0 \\ & 42.5 \\ & 41.5 \\ & \hline \end{aligned}$ | - |
| Switch Isolation, ANT to Load | Rx Mode, 2.6 GHz Rx Mode, 3.5 GHz | dB | - | $\begin{aligned} & 20 \\ & 17 \end{aligned}$ | - |
| Switch Isolation, ANT to Rx output | Tx Mode | dB | - | 72 | - |

5. Test conditions: both Rx channels are enabled. RF signal is present at Antenna port on one of the channels only. The isolation is defined as the difference between the 2 RX output signal levels.

## Control Truth Table

| Mode | SWCTRL_AB | LNAEN_AB | BP_A/B | Note |
| :---: | :---: | :---: | :---: | :---: |
| RX mode | Low or open | Low or open | Low | HGM $^{6}$ |
| RX mode | Low or open | Low or open | High | LGM $^{7}$ |
| TX mode | High | High | Low | Power down |
| TX mode | High | High | High | Power down |

6. HGM: High Gain Mode.
7. LGM: Low Gain Mode.

## Absolute Maximum Ratings ${ }^{8,9}$

| Parameter | Absolute Maximum |
| :---: | :---: |
| Antenna Input Power ${ }^{10}$ Freq. $=2.6 \mathrm{GHz}$ : RX Mode TX Mode | 22 dBm LTE (8 dB PAR), 22 dBm CW 43 dBm LTE (8 dB PAR), 43 dBm CW |
| DC Voltages: <br> ANT_A/B, LOAD_A/B, RXOUT_A/B VDD_A/B, SWCTRL_A/B, LNAEN_A/B, BP_A/B | $\begin{aligned} & -0.3 \text { to }+3.6 \mathrm{~V} \\ & -0.3 \text { to }+5.5 \mathrm{~V} \\ & -0.3 \text { to }+3.6 \mathrm{~V} \end{aligned}$ |
| ```Junction Temperature: RX Mode 11,13 TX Mode }\mp@subsup{}{}{11,13 TX Mode }\mp@subsup{}{}{10``` | $\begin{aligned} & +150^{\circ} \mathrm{C} \\ & +125^{\circ} \mathrm{C} \\ & +140^{\circ} \mathrm{C} \end{aligned}$ |
| Operating Temperature ${ }^{12}$ | $-40^{\circ} \mathrm{C}$ to $+105^{\circ} \mathrm{C}$ |
| Storage Temperature | $-55^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ |

8. Exceeding any one or combination of these limits may cause permanent damage to this device.
9. MACOM does not recommend sustained operation near these survivability limits.
10. Single event, up to 10 seconds duration.
11. Operating at nominal conditions with $T_{j} \leq+150^{\circ} \mathrm{C}$ ( $R X$ Mode) and $T_{j} \leq+125^{\circ} \mathrm{C}$ (TX Mode) will ensure MTTF $\gg 1 \times 10^{6}$ hours.
12. Operating/Case temperature $\left(T_{C}\right)$ is the temperature of the exposed paddle.
13. Junction Temperature $\left(T_{J}\right)=T_{C}+\Theta_{J C} * P_{\text {DISS }}$ where $P_{\text {DISS }}$ is the total DC \& RF dissipated power.

- RX Mode: Typical thermal resistance $\left(\Theta_{\mathrm{Jc}}\right)=33.4^{\circ} \mathrm{C} / \mathrm{W}$.
- TX Mode: Typical thermal resistance $\left(\Theta_{\mathrm{Jc}}\right)=9.8^{\circ} \mathrm{C} / \mathrm{W}$.


## Handling Procedures

Please observe the following precautions to avoid damage:

## Static Sensitivity

These electronic devices are sensitive to electrostatic discharge (ESD) and can be damaged by static electricity. Proper ESD control techniques should be used when handling these devices.

## Power Supplies

De-coupling capacitors should be placed at the $\mathrm{V}_{\mathrm{DD}}$ supply pin to minimize noise and fast transients. Supply voltage change or transients should have a slew rate smaller than $1 \mathrm{~V} / 10 \mu \mathrm{~s}$. In addition, all control pins should remain at $0 \mathrm{~V}(+/-0.3 \mathrm{~V})$ and no RF power should be applied while the supply voltage ramps or while it returns to zero.

| Parameter | Rating | Standard |
| :---: | :---: | :---: |
| Human Body <br> Model (HBM) | 500 V | ESDA/JEDEC |
| Class 1B | JS-001 |  |
| Charged Device <br> Model (CDM) | 1000 V <br> (Class C3) | ESDA/JEDEC <br> JS-002 |

## PCB Layout



## Parts List

| Part | Value | Case Style |
| :---: | :---: | :---: |
| C7, C8, C106, <br> C206 | 5 pF | 0402 |
| C107, C207 | 470 pF | 0402 |
| C108, C208 | 10 nF | 0402 |
| C109, C209 | $10 \mu \mathrm{~F}$ | 0603 |
| C301 - C306 | 20 pF | 0402 |
| R1, R2, R3, R4, <br> R6, R7 | 0 R | 0402 |
| R16, R26 | DNP | 0402 |
| R5, R8, R13, R23 | $1 \mathrm{k} \Omega$ | 0402 |

14. Proposed SMB parts list provides supply biasing for CH 1 and CH 2 via DC headers $(\mathrm{J} 15 / \mathrm{J} 13)$ with separate $\mathrm{V}_{\mathrm{DD} 1}$ and $\mathrm{V}_{\mathrm{DD} 2}$ supplies. A single $V_{D D}$ supply may also be provided at the SMA connector (J6) by removing R1/R2 and populating R16/ R26 with 0 R instead.

Application Schematic


# Integrated Dual Channel Switch and LNA Module 2-6 GHz 

MAMF-011133
Rev. V2

## Typical Performance Curves:

$P_{\text {IN }}=-35 \mathrm{dBm}, \mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V}, \mathrm{~T}_{\mathrm{C}}=+25^{\circ} \mathrm{C}, \mathrm{Z}_{0}=50 \Omega$ (unless otherwise indicated)

Channel A LNA Gain over swept Frequency (\&
Temp.) in Rx High Gain Mode


Channel A ANT Port Return Loss over swept
Frequency (\& Temp.) in Rx High Gain Mode


Channel A RXOUT Port Return Loss over swept Frequency (\& Temp.) in Rx High Gain Mode


Channel B LNA Gain over swept Frequency (\& Temp.) in Rx High Gain Mode


Channel B ANT Port Return Loss over swept Frequency (\& Temp.) in Rx High Gain Mode


ChanneI B RXOUT Port Return Loss over swept Frequency (\& Temp.) in Rx High Gain Mode


## Typical Performance Curves:

$P_{\text {IN }}=-35 \mathrm{dBm}, \mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V}, \mathrm{~T}_{\mathrm{C}}=+25^{\circ} \mathrm{C}, \mathrm{Z}_{0}=50 \Omega$ (unless otherwise indicated)

Channel A LNA Gain over swept Frequency (\&
Temp.) in Rx Low Gain Mode


Channel A ANT Port Return Loss over swept Frequency (\& Temp.) in Rx Low Gain Mode


Channel A RXOUT Port Return Loss over swept Frequency (\& Temp.) in Rx Low Gain Mode


Channel B LNA Gain over swept Frequency (\& Temp.) in Rx Low Gain Mode


Channel B ANT Port Return Loss over swept Frequency (\& Temp.) in Rx Low Gain Mode


Channel B RXOUT Port Return Loss over swept Frequency (\& Temp.) in Rx Low Gain Mode


## Typical Performance Curves:

$P_{\text {IN }}=-35 \mathrm{dBm}, \mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V}, \mathrm{~T}_{\mathrm{C}}=+25^{\circ} \mathrm{C}, \mathrm{Z}_{0}=50 \Omega$ (unless otherwise indicated)

Channel A LNA Noise Figure over swept Frequency (\& Temp.) in Rx High Gain Mode


Channel A LNA Noise Figure over swept Frequency (\& Temp.) in Rx Low Gain Mode


Channel A ANT to LOAD Isolation over swept Frequency (\& Temp.) in Rx High Gain Mode


Channel B LNA Noise Figure over swept Frequency (\& Temp.) in Rx High Gain Mode


Channel B LNA Noise Figure over swept Frequency (\& Temp.) in Rx Low Gain Mode


Channel B ANT to LOAD Isolation over swept Frequency (\& Temp.) in Rx High Gain Mode


## Typical Performance Curves:

$P_{\text {IN }}=-35 \mathrm{dBm}, \mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V}, \mathrm{~T}_{\mathrm{C}}=+25^{\circ} \mathrm{C}, \mathrm{Z}_{0}=50 \Omega$ (unless otherwise indicated)

Channel A ANT to LOAD Isolation over swept Frequency (\& Temp.) in Rx Low Gain Mode


Channel A LNA Output P1dB over swept Frequency (\& Temp.) in Rx High Gain Mode


Channel A LNA Output P1dB over swept Frequency (\& Temp.) in Rx Low Gain Mode.


Channel B ANT to LOAD Isolation over swept Frequency (\& Temp.) in Rx Low Gain Mode


Channel B LNA Output P1dB over swept Frequency (\& Temp.) in Rx High Gain Mode


Channel B LNA Output P1dB over swept Frequency (\& Temp.) in Rx Low Gain Mode


## Typical Performance Curves:

$P_{\text {IN }}=-35 \mathrm{dBm}, \mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V}, \mathrm{~T}_{\mathrm{C}}=+25^{\circ} \mathrm{C}, \mathrm{Z}_{0}=50 \Omega$ (unless otherwise indicated)

Channel A LNA Output P1dB over swept Frequency (\& $V_{D D}$ ) in Rx High Gain Mode


Channel A LNA Output P1dB over swept Frequency (\& $V_{D D}$ ) in Rx Low Gain Mode


Channel A LNA Gain over Frequency (\& $V_{D D}$ ) in Rx High Gain Mode


Channel B LNA Output P1dB over swept Frequency (\& $V_{D D}$ ) in Rx High Gain Mode


Channel B LNA Output P1dB over swept Frequency ( \& $V_{D D}$ ) in Rx Low Gain Mode


Channel B LNA Gain over Frequency (\& $V_{D D}$ ) in Rx High Gain Mode


## Integrated Dual Channel Switch and LNA Module

## Typical Performance Curves:

$P_{\text {IN }}=-35 \mathrm{dBm}, \mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V}, \mathrm{~T}_{\mathrm{C}}=+25^{\circ} \mathrm{C}, \mathrm{Z}_{0}=50 \Omega$ (unless otherwise indicated)

Channel A OIP3 over swept Frequency (\& Temp.) with $P_{\text {out }} /$ Tone $=10 \mathrm{dBm} \& 10 \mathrm{MHz}$ tone spacing in HGM.


Channel A OIP3 over swept Frequency (\& Temp.) with $P_{\text {out }} /$ Tone $=3 \mathrm{dBm} \& 10 \mathrm{MHz}$ tone spacing in HGM.


Channel A OIP3 over swept frequency ( \& V $V_{D D}$ ) with $P_{\text {out }} / T o n e=10 \mathrm{dBm}$ \& 10 MHz tone spacing in HGM.


Channel B OIP3 over swept Frequency (\& Temp.) with $P_{\text {out }} / T o n e=10 \mathrm{dBm} \& 10 \mathrm{MHz}$ tone spacing in HGM.


Channel B OIP3 over swept Frequency (\& Temp.) with $P_{\text {out }} /$ Tone $=3 \mathrm{dBm} \& 10 \mathrm{MHz}$ tone spacing in HGM.


Channel B OIP3 over swept frequency (\& VDD) with $P_{\text {out }} / T o n e=10 \mathrm{dBm} \& 10 \mathrm{MHz}$ tone spacing in HGM.


## Typical Performance Curves:

$P_{\text {IN }}=-35 \mathrm{dBm}, \mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V}, \mathrm{~T}_{\mathrm{C}}=+25^{\circ} \mathrm{C}, \mathrm{Z}_{0}=50 \Omega$ (unless otherwise indicated)

Channel A OIP3 over swept Frequency (\& Temp.) with
$P_{\text {out }} /$ Tone $=3 \mathrm{dBm} \& 10 \mathrm{MHz}$ tone spacing in LGM.


Channel A OIP3 over swept Frequency (\& Temp.) with $P_{\text {out }} /$ Tone $=0 \mathrm{dBm} \& 10 \mathrm{MHz}$ tone spacing in LGM.


Channel A OIP3 over swept Frequency (\& VDD) with $P_{\text {out }} /$ Tone $=3 \mathrm{dBm}$ \& 10 MHz tone spacing in LGM.


Channel B OIP3 over swept Frequency (\& Temp.) with $P_{\text {out/ }} /$ Tone $=3 \mathrm{dBm} \& 10 \mathrm{MHz}$ tone spacing in LGM.


Channel B OIP3 over swept Frequency (\& Temp.) with $P_{\text {out }} /$ Tone $=0 \mathrm{dBm} \& 10 \mathrm{MHz}$ tone spacing in LGM.


Channel B OIP3 over swept Frequency (\& VDD with $P_{\text {out/Tone }}=3 \mathrm{dBm}$ \& 10 MHz tone spacing in LGM.


Rev. V2

## Typical Performance Curves:

$P_{\text {IN }}=-35 \mathrm{dBm}, \mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V}, \mathrm{~T}_{\mathrm{C}}=+25^{\circ} \mathrm{C}, \mathrm{Z}_{0}=50 \Omega$ (unless otherwise indicated)

Channel A OIP3 over swept frequency with Pout/ Tone = 6 dBm with $10 \mathrm{MHz} \& 50 \mathrm{MHz}$ tone spacing in


Channel B OIP3 over swept frequency with $P_{\text {out }} /$ Tone = 6 dBm with $10 \mathrm{MHz} \& 50 \mathrm{MHz}$ tone spacing in


## Typical Performance Curves:

$P_{\text {IN }}=-35 \mathrm{dBm}, \mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V}, \mathrm{~T}_{\mathrm{C}}=+25^{\circ} \mathrm{C}, \mathrm{Z}_{0}=50 \Omega$ (unless otherwise indicated)

Channel A Wideband LNA Gain ${ }^{15}$ over swept Frequency in Rx High Gain Mode


Channel A Wideband ANT Port Return Loss ${ }^{15}$ over swept Frequency in Rx High Gain Mode


Channel A Wideband RXOUT Port Return Loss ${ }^{15}$ over swept Frequency in Rx High Gain Mode


Channel B Wideband LNA Gain ${ }^{15}$ over swept Frequency in Rx High Gain Mode


Channel B Wideband ANT Port Return Loss ${ }^{15}$ over swept Frequency in Rx High Gain Mode


Channel B Wideband RXOUT Port Return Loss ${ }^{15}$ over swept Frequency in Rx High Gain Mode

15. As measured at the Sample Board RF Launcher Reference Planes

## Typical Performance Curves:

$P_{\text {IN }}=-35 \mathrm{dBm}, \mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V}, \mathrm{~T}_{\mathrm{C}}=+25^{\circ} \mathrm{C}, \mathrm{Z}_{0}=50 \Omega$ (unless otherwise indicated)

## Channel A Wideband LNA Gain ${ }^{16}$ over swept

 Frequency in Rx Low Gain Mode

Channel A Wideband ANT Port Return Loss ${ }^{16}$ over swept Frequency in Rx Low Gain Mode


Channel A Wideband RXOUT Port Return Loss ${ }^{16}$ over swept Frequency in Rx Low Gain Mode


Channel B Wideband LNA Gain ${ }^{16}$ over swept Frequency in Rx Low Gain Mode


Channel B Wideband ANT Port Return Loss ${ }^{16}$ over swept Frequency in Rx Low Gain Mode


Channel B Wideband RXOUT Port Return Loss ${ }^{16}$ over swept Frequency in Rx Low Gain Mode

16. As measured at the Sample Board RF Launcher Reference Planes

## Typical Performance Curves:

$\mathrm{P}_{\text {IN }}=-10 \mathrm{dBm}, \mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V}, \mathrm{~T}_{\mathrm{C}}=+25^{\circ} \mathrm{C}, \mathrm{Z}_{0}=50 \Omega$ (unless otherwise indicated)

Channel A Switch Insertion Loss over swept Frequency (\& Temp.) in Tx Mode


Channel A ANT Port Return Loss over swept Frequency (\& Temp.) in Tx Mode


Channel A LOAD Port Return Loss over swept Frequency (\& Temp.) in Tx Mode


Channel B Switch Insertion Loss over swept Frequency (\& Temp.) in Tx Mode


Channel B ANT Port Return Loss over swept Frequency (\& Temp.) in Tx Mode


Channel B LOAD Port Return Loss over swept Frequency (\& Temp.) in Tx Mode


## Typical Performance Curves:

$P_{\text {IN }}=-10 \mathrm{dBm}, \mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V}, \mathrm{~T}_{\mathrm{C}}=+25^{\circ} \mathrm{C}, \mathrm{Z}_{0}=50 \Omega$ (unless otherwise indicated)

Channel A ANT to RXOUT Isolation over swept Frequency (\& Temp.) in Tx Mode


Channel A Switch Insertion Loss over swept Frequency ( \& $V_{D D}$ ) in Tx Mode


Switch Compression over swept ANT Input Power (\& Temp.) at 2.6 GHz in Tx Mode


Channel B ANT to RXOUT Isolation over swept Frequency (\& Temp.) in Tx Mode


Channel B Switch Insertion Loss over swept Frequency ( \& VD) in Tx Mode


Switch ANT Input P0.1dB Compression Point over swept Frequency (\& Temp.) in Tx Mode


## Typical Performance Curves:

$P_{\text {IN }}=-10 \mathrm{dBm}, \mathrm{V}_{\mathrm{DD}}=5 \mathrm{~V}, \mathrm{~T}_{\mathrm{C}}=+25^{\circ} \mathrm{C}, \mathrm{Z}_{0}=50 \Omega$ (unless otherwise indicated)

Channel A Wideband Switch Insertion Loss ${ }^{17}$ over swept Frequency in Tx Mode


Channel A Wideband ANT Port Return Loss ${ }^{17}$ over swept Frequency in Tx Mode


Channel A Wideband LOAD Port Return Loss ${ }^{17}$ over swept Frequency in Tx Mode


Channel B Wideband Switch Insertion Loss ${ }^{17}$ over swept Frequency in Tx Mode


Channel B Wideband ANT Port Return Loss ${ }^{17}$ over swept Frequency in Tx Mode


Channel B Wideband LOAD Port Return Loss ${ }^{17}$ over swept Frequency in Tx Mode

17. As measured at the Sample Board RF Launcher Reference Planes

## Lead-Free 6 mm 40-Lead QFN ${ }^{\dagger}$



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[^0]:    * Restrictions on Hazardous Substances, compliant to current RoHS EU directive.

[^1]:    $\dagger^{\dagger}$ Reference Application Note S2083 for lead-free solder reflow recommendations.
    Meets JEDEC moisture sensitivity level 3 requirements.
    Plating is NiPdAuAg

